#### THIN SMD LOW/MEDIUM-FREQUENCY CRYSTAL UNIT

## **MC-156**

- High-density mounting-type SMD of 1.5mm thickness.
- Small packaging area and light weight.
- Excellent shock resistance and environmental capability.
- Most suitable for small communications devices.



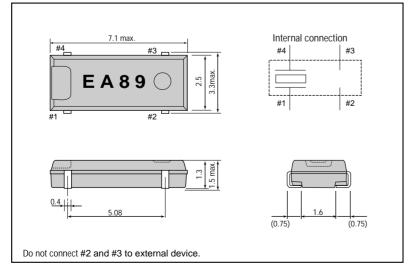
### Specifications (characteristics)

| Item                               |                       | Symbol         | Specifications        |   | Remarks   |
|------------------------------------|-----------------------|----------------|-----------------------|---|---|
| Nominal frequency                  |                       | f              | 32.768kHz             | 75.000kHz                               | please contact us for inquiries about usable frequencies  |
| Temperature range                  | Storage temperature   | Tstg           | -55°C t               | o +125°C                                |   |
|                                    | Operating temperature | Topr           | -40°C                 | to +85°C                                |   |
| Maximum drive level                |                       | GL             | 1.0μ\                 | N max.                                  | Operating drive level 0.5µW max.  |
| Soldering condition                |                       | Tsol           |                       | 60°C within 10 sec.<br>°C within 3 min. |   |
| Frequency tolerance(standard)      |                       | Δf/f           | ±20ppm                | ı, ±50ppm                               | Ta=25°C, DL=0.1μW   |
| Peak temperature(frequency)        |                       | θТ             | 25 <sup>-</sup> (     | C ±5°C                                  |   |
| Temperature coefficient(frequency) |                       | a              | -0.04ppm/ °C² max.    |   |   |
| Load capacitance                   |                       | CL             | 6pF to ∞              |   | Please specify  |
| Series resistance                  |                       | R <sub>1</sub> | 65 kΩ max.            | 30kΩ                                    |   |
| Motional capacitance               |                       | C <sub>1</sub> | 1.9fF typ.            |   |   |
| Shunt capacitance                  |                       | Co             | 0.8pF typ.            |   |   |
| Insulation resistance              |                       | IR             | $500$ M $\Omega$ min. |   |   |
| Aging                              |                       | fa             | ±3ppm/                | year max.                               | Ta=25°C ±3°C, first year  |
| Shock resistance                   |                       | S.R.           | ±5pp                  | m max.                                  | Three drops on a hard board from 75 cm or excitation test with 3000G x 0.3ms x 1/2 sine wave x 3 directions |

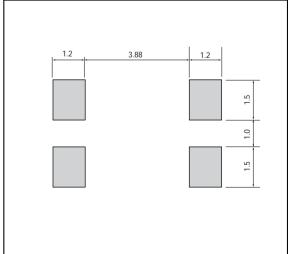
(Unit: mm)

 $\label{thm:may-be-exposed} \mbox{Metal may be exposed on the top of this product. This won't affect any quality, reliability or electrical spec.}$ 

#### External dimensions



#### Recommended soldering pattern (Unit: mm)



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### THE CRYSTALMASTER



# ENERGY SAVING EPSON

EPSON offers effective savings to its customers through a wide range of electronic devices, such as semiconductors, liquid crystal display (LCD) modules, and crystal devices. These savings are achieved through a sophisticated melding of three different efficiency technologies.

Power saving technology provides low power consumption at low voltages.

Space saving technology provides further reductions in product size and weight through super-precise processing and high-density assembly technology.

Time saving technology shortens the time required for design and development on the customer side and shortens delivery times.



Our concept of Energy Saving technology conserves resources by blending the essence of these three efficiency technologies. The essence of these technologies is represented in each of the products that we provide to our customers.

In the industrial sector, leading priorities include measures to counter the greenhouse effect by reducing CO2,

measures to preserve the global environ-

ment, and the development of energyefficient products. Environmental
problems are of global concern, and
although the contribution of energysaving technology developed by
EPSON may appear insignificant,
we seek to contribute to the development of energy-saving products by our

customers through the utilization of our electronic devices. EPSON is committed to the conservation of energy, both for the sake of people and of the planet on which we live.





Resource

Saving



SEIKO EPSON CORP. QUARTZ DEVICE DIVISION acquired ISO9001 and ISO14001 certification by B.V.Q.I. (Bureau Veritas Quality International).

ISO9001 in October, 1992. ISO14001 in November,1997.

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